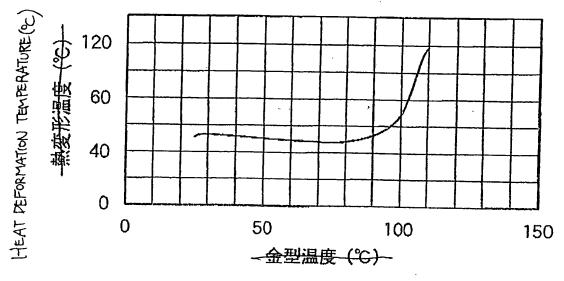
Fig. 1

「成形時の金型温度と熱変形温度の関係-



MOLD TEMPERATURE (&)

Toru YANO et al. Q80109 BIODEGRADABLE RESIN COMPOSITION

AND...... Filing Date: February 27, 2004 Mark Boland 202-663-7949